



InGaAs p-i-n Photodiode

35PD500-TO

The 35PD500-TO, an InGaAs photodiode with a 500 μ m photosensitive region packaged in a TO-46 header, is a versatile device applicable to high sensitivity instrumentation, laser back-facet monitoring, and low-bit-rate telecomm and datacomm transmission. Planar semiconductor design and dielectric passivation provide for superior noise performance. Reliability is assured by hermetic sealing and a 100% purge burn-in (200°C, 15 hours, $V_r = 15V$). Chips can also be attached and wire bonded to customer-supplied or other specified packages.

Features

Planar Structure
Dielectric Passivation
100% Purge Burn-In
High Responsivity

| Device Characteristics | | | | | | |
|--------------------------|-----------------|------|-----|-----|-------|-----------------|
| Parameters | Test Conditions | Min | Typ | Max | Units | |
| Operating Voltage | - | - | - | -10 | Volts | |
| Dark Current | -5V | - | - | 25 | nA | |
| Capacitance | -5V | - | 20 | - | pF | |
| Responsivity | 1300nm | 0.80 | 0.9 | - | A/W | |
| | 1500nm | - | 1.0 | - | A/W | |
| Rise/Fall | - | - | - | 3 | ns | |
| Absolute Maximum Ratings | | | | | | |
| Reverse Voltage | | | | | | 15 Volts |
| Forward Current | | | | | | 50 mA |
| Reverse Current | | | | | | 5 mA |
| Operating Temperature | | | | | | -40°C to + 85°C |
| Storage Temperature | | | | | | -40°C to + 85°C |
| Soldering Temperature | | | | | | 250°C |